TEC0330 Test Board

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This TEC0330 reference design in plements the \$15338 Configuration, DDR Configuration and PCIe Core Example Design 1.4.1 Software

Refer to http://trenz.org/te-0330-info/for the current online version of this manual and other available documentation.

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Date 5 Software Design - Vitis 5.1 Application	Project Built	Authors	Description
2022-09-22	test_board_noprebuidRvivado_2021.2-build_17_20220922 155804.zip aTE00336-	Waldemar Hanemann	• version 2021.2 update
2018-10-30 O 7.5 Linging on Clability 7.6 Copyright Notice 7.7 Technology Licenses 7.8 Environmental Protecti 7.9 REACH, RoHS and Wi 8 Table of contents		John Hartfiel	• initial release

Design Revision History

Release Notes and Know Issues

Issues	Description	Workaround	To be fixed version	

DDR3 ECC SODIMM	DDR3 does not work with ECC enabled	for Block Design MIG with AXI Interface, create 64Bit MIG for RTL MIG with Native Interface, disable ECC on MIG configuration and Use 72Bit for Data	
		use 72Bit for Data	

Known Issues

Requirements

Software

Software	Version	Note
Vitis	2021.2	needed, Vivado is included into Vitis installation
Clockbuilder Pro	4.5(used in this design)	optional

Software

Hardware

Basic description of TE Board Part Files is available on TE Board Part Files.

Complete List is available on <design name>/board_files/*_board_files.csv

Design supports following modules:

Module Model	Board Part Short Name	PCB Revision Support	DDR	QSPI Flash	Others	Notes
TEC0330-04- (330-2C)	330_2	REV04	DDR3 ECC SODIMM	32MB		• DDR configur ed for AW24P7 228BLK 0M (8GB)
TEC0330-05	330_2	REV05	DDR3 ECC SODIMM	32MB		• DDR configur ed for AW24P7 228BLK 0M (8GB)

	TEC0330-05- S	330_2	REV05	DDR3 ECC SODIMM	32MB		• DDR configur ed for AW24P7 228BLK 0M (8GB)
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Hardware Modules

Design supports following carriers:

Carrier Model		Notes
PC with PCIe Ca	ard slot	Card need 3.3V from PCIe and 12V from ATX connector

Hardware Carrier

Additional HW Requirements:

Additional Hardware	Notes
JTAG Programmer	 TE0790 with TE0791 for CPLD or FPGA Xilinx compatible JTAG programmer for FPGA
DDR3 (204 Pin with ECC)	in this design used:AW24P7228BLK0M (max. 8GB)

Additional Hardware

Content

For general structure and of the reference design, see Project Delivery - AMD devices

Design Sources

Туре	Location	Notes
Vivado	<pre><pre><pre><pre><pre><pre><pre><pre></pre></pre></pre></pre></pre></pre></pre></pre>	Vivado Project will be generated by TE Scripts
Vitis	<pre><pre><pre><pre><pre><pre><pre><pre></pre></pre></pre></pre></pre></pre></pre></pre>	Additional Software Template for Vitis and apps_list.csv with settings automatically for Vitis app generation

Design sources

Additional Sources

Туре	Location	Notes
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SI5338	<pre><pre><pre><pre><pre><pre><pre><pre></pre></pre></pre></pre></pre></pre></pre></pre>	SI5338 Project with current PLL Configuration
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Additional design sources

Prebuilt

File	File-Extension	Description
BIT-File	*.bit	FPGA (PL Part) Configuration File
DebugProbes-File	*.ltx	Definition File for Vivado/Vivado Labtools Debugging Interface
Diverse Reports		Report files in different formats
Hardware-Platform- Specification-Files	*.xsa	Exported Vivado hardware description file for Vitis and PetaLinux
LabTools Project-File	*.lpr	Vivado Labtools Project File
MCS-File	*.mcs	Flash Configuration File with Boot-Image (MicroBlaze or FPGA part only)
MMI-File	*.mmi	File with BRAM-Location to generate MCS or BIT-File with *. elf content (MicroBlaze only)
Software-Application-File	*.elf	Software Application for Zynq or MicroBlaze Processor Systems

Prebuilt files (only on ZIP with prebult content)

Download

Reference Design is only usable with the specified Vivado/Vitis/PetaLinux version. Do never use different Versions of Xilinx Software for the same Project.

Reference Design is available on:

• TEC0330 "Test Board" Reference Design

Design Flow



Reference Design is available with and without prebuilt files. It's recommended to use TE prebuilt files for first lunch.

Trenz Electronic provides a tcl based built environment based on Xilinx Design Flow.

See also: AMD Development Tools#XilinxSoftware-BasicUserGuides

- AMD Development Tools#XilinxSoftware-BasicUserGuidesVivado Projects TE Reference Design
- Project Delivery.

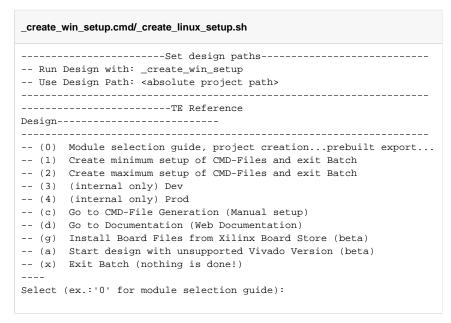
The Trenz Electronic FPGA Reference Designs are TCL-script based project. Command files for execution will be generated with "_create_win_setup.cmd" on Windows OS and "_create_linux_setup.sh" on Linux OS.

TE Scripts are only needed to generate the vivado project, all other additional steps are optional and can also executed by Xilinx Vivado/Vitis GUI. For currently Scripts limitations on Win and Linux OS see: Project Delivery Currently limitations of functionality



Caution! Win OS has a 260 character limit for path lengths which can affect the Vivado tools. To avoid this issue, use Virtual Drive or the shortest possible names and directory locations for the reference design (for example "x:\roject folder>")

1. Run _create_win_setup.cmd/_create_linux_setup.sh and follow instructions on shell:



- 2. Press 0 and enter to start "Module Selection Guide"
- (optional Win OS) Generate Virtual Drive or use short directory for the reference design (for example x:\<design name>)
- Create project and follow instructions of the product selection guide, settings file will be configured automatically during this process.
 - optional for manual changes: Select correct device and Xilinx install path on "design_basic_settings.cmd" and create Vivado project with "vivado_create_project_guimode.cmd"



Note: Select correct one, see also Vivado Board Part Flow

5. Create hardware description file (.xsa file) for PetaLinux project and export to prebuilt folder

run on Vivado TCL (Script generates design and export files into "roject
folder>\prebuilt\hardware\<short name>")

```
TE::hw_build_design -export_prebuilt
```







Using Vivado GUI is the same, except file export to prebuilt folder.

6. Generate Programming Files with Vitis

run on Vivado TCL (Script generates applications and bootable files, which are defined in "test_board\sw_lib\apps_list.csv")

```
TE::sw_run_vitis -all
TE::sw_run_vitis (optional; Start Vitis from Vivado GUI or start with TE Scripts on Vivado TCL)
```



TCL scripts generate also platform project, this must be done manually in case GUI is used. See Vitis

- 7. (Optional) BlockRam Firmware Update
 - a. Copy "roject folder>\prebuilt\software\<short name>\spi_bootloader.elf" into "project folder>\firmware\microblaze_0\"
 - b. Copy "<project folder>\workspace\sdk\scu\Release\scu.elf" into "\firmware\microblaze_mcs_0\"
 - c. Regenerate Vivado Project or Update Bitfile only with "spi_bootloader.elf" and "scu_te0712.elf"

```
TE::hw_build_design -export_prebuilt
TE::sw_run_vitis -all
```

Launch

Programming



Check Module and Carrier TRMs for proper HW configuration before you try any design.

Reference Design is also available with prebuilt files. It's recommended to use TE prebuilt files for first launch.

Xilinx documentation for programming and debugging: Vivado/Vitis/SDSoC-Xilinx Software Programming and Debugging

Get prebuilt boot binaries

- 1. Run _create_win_setup.cmd/_create_linux_setup.sh and follow instructions on shell
- 2. Press 0 and enter to start "Module Selection Guide"
 - a. Select assembly version
 - b. Validate selection
 - c. Select create and open delivery binary folder





Note: Folder ""roject folder>_binaries_<Article Name>" with subfolder
"boot_<app name>" for different applications will be generate

QSPI-Boot mode

- 1. Connect JTAG and Power ON PC
- Open Vivado Project with "vivado_open_existing_project_guimode.cmd" or if not created, create with "vivado_create_project_guimode.cmd"
- 3. Type on Vivado TCL Console:

```
run on Vivado TCL (Script programs u-boot.mcs onto QSPI flash)

TE::pr_program_flash -swapp hello_tec0330
```

4. Reboot PC

SD-Boot mode

Not used on this Example.

JTAG

• Connect Vivado HW Manager and program FPGA

Usage

- 1. Prepare HW like described on section Programming
- 2. Power On PCB

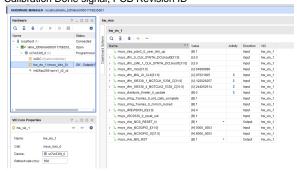
Note: 1. FPGA Load Bitfile into FPGA,MCS configure SI5338 and starts microblaze design, modified SPI Bootloader to load hello_tec0330 application from QSPI into DDR (Depends on linker script)

JTAG/UART Console:

- Launch XSCT or the XSDB console on Vitis:
 - o type: connect
 - o type: targets -set -filter {name =~ "MicroBlaze Debug*"} -index 0
 - o type: jtagterminal -start
 - Separate console starts printing out four internal frequencies(can also be seen in the hardware manager) and "Hello Trenz Module" in a loop:

Vivado HW Manager:

- Open Vivado HW Manager
 Add VIO to Dashboard
- 3. Set Radix to unsigned integer for FMeterCLKs (fm_*). Note measurement is not accurate
- 4. Control:
 - a. MCS Reset b. MIG Reset
- 5. Read: SI5338 CLKs (Unit Hz), PCIe Core User Link Up signal, MIG MMCM Lock signal, MIG Init Calibration Done signal, PCB Revision ID



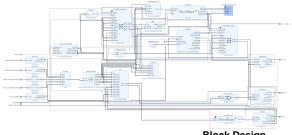
PC:

• Use for example PCI-Z (Win) or KInfoCenter (Linux) to detect PCIe Card



System Design - Vivado

Block Design



Block Design

Constraints

Basic module constrains

```
#
# Default common settings that do not depend assembly variant
#
set_property BITSTREAM.GENERAL.COMPRESS TRUE [current_design]
set_property BITSTREAM.CONFIG.CONFIGRATE 66 [current_design]
set_property BITSTREAM.CONFIG.SPI_32BIT_ADDR YES [current_design]
set_property BITSTREAM.CONFIG.SPI_BUSWIDTH 4 [current_design]
set_property BITSTREAM.CONFIG.M1PIN PULLNONE [current_design]
set_property BITSTREAM.CONFIG.M2PIN PULLNONE [current_design]
set_property BITSTREAM.CONFIG.M0PIN PULLNONE [current_design]
set_property BITSTREAM.CONFIG.M0PIN PULLNONE [current_design]
set_property BITSTREAM.CONFIG.WSR_ACCESS TIMESTAMP [current_design]
```

```
_i_common.xdc

#
#
#
set_property BITSTREAM.CONFIG.UNUSEDPIN PULLDOWN [current_design]
```

Design specific constrain

```
_i_io.xdc
#-----
#IIC to CPLD
set_property PACKAGE_PIN W29 [get_ports SCF_0_cpld_25_scl]
set_property PACKAGE_PIN W26 [get_ports SCF_0_cpld_19_oe]
set_property PACKAGE_PIN V29 [get_ports SCF_0_cpld_24_sda]
set_property IOSTANDARD LVCMOS18 [get_ports SCF_0_cpld_25_scl]
set_property IOSTANDARD LVCMOS18 [get_ports SCF_0_cpld_19_oe]
set_property IOSTANDARD LVCMOS18 [get_ports SCF_0_cpld_24_sda]
#PCIe
set_property PACKAGE_PIN E33 [get_ports FEX_4_N]
set_property IOSTANDARD LVCMOS18 [get_ports FEX_4_N]
set_property PACKAGE_PIN AD6 [get_ports {CLK_PCIe_100MHz_clk_p[0]}]
#todo check auto placement:
set_property CLOCK_DEDICATED_ROUTE FALSE [get_nets msys_i/axi_pcie3_0/inst
/pcie3_ip_i/inst/gt_top_i/pipe_wrapper_i/pipe_lane[0].gt_wrapper_i
/CLK_TXOUTCLK]
#-----
#Revision ID
set_property PACKAGE_PIN AP27 [get_ports {REV_ID[0]}]
set_property PACKAGE_PIN AN27 [get_ports {REV_ID[1]}]
set_property PACKAGE_PIN AP26 [get_ports {REV_ID[2]}]
set_property PACKAGE_PIN AP25 [get_ports {REV_ID[3]}]
set_property IOSTANDARD LVCMOS18 [get_ports {REV_ID[*]}]
#-----
```

```
#QSPI
set_property PACKAGE_PIN AL33 [get_ports {spi_rtl_ss_io[0]}]
set_property IOSTANDARD LVCMOS18 [get_ports {spi_rtl_ss_io[0]}]
set_property PACKAGE_PIN AN33 [get_ports spi_rtl_io0_io]
set_property PACKAGE_PIN AN34 [get_ports spi_rtl_io1_io]
set_property PACKAGE_PIN AK34 [get_ports spi_rtl_io2_io]
set_property PACKAGE_PIN AL34 [get_ports spi_rtl_io3_io]
set_property IOSTANDARD LVCMOS18 [get_ports spi_rtl_io0_io]
set_property IOSTANDARD LVCMOS18 [get_ports spi_rtl_iol_io]
set_property IOSTANDARD LVCMOS18 [get_ports spi_rtl_io2_io]
set_property IOSTANDARD LVCMOS18 [get_ports spi_rtl_io3_io]
#CLKS
##SI5338_0_DDR3_CLK #diff 1.5V AG17/AH17
set_property PACKAGE_PIN AG17 [get_ports {SI5338_0_DDR3_CLK_clk_p}]
set_property IOSTANDARD DIFF_SSTL15 [get_ports {SI5338_0_DDR3_CLK_clk_p}]
##SI5338_1_MGTCLK_5338_C #diff MGT 1.8V AB6/AB5
set_property PACKAGE_PIN AB6 [get_ports {SI5338_1_MGTCLK_5338_C_clk_p[0]}]
###SI5338_3_LMK_CLK #diff MGT 1.8V to LMK CLKin1
##SI5338_4_MGTCLK2_5338_C #diff MGT 1.8V H6/H5
set_property PACKAGE_PIN H6 [get_ports {SI5338_4_MGTCLK2_5338_C_clk_p[0]}]
##LMK_0_CLK_SYNTH_DCLKout0 #diff 1.8V AD29/AE29
set_property PACKAGE_PIN AD29 [get_ports {LMK_0_CLK_SYNTH_DCLKout0_clk_p
[0]}]
set_property IOSTANDARD LVDS [get_ports {LMK_0_CLK_SYNTH_DCLKout0_clk_p
[0]}]
set_property DIFF_TERM TRUE [get_ports {LMK_0_CLK_SYNTH_DCLKout0_clk_p[0]}]
##LMK_1_CLK_SYNTH_DCLKout1 #diff 1.8V AE31/AF31
set_property PACKAGE_PIN AE31 [get_ports {LMK_1_CLK_SYNTH_DCLKout1_clk_p
set_property IOSTANDARD LVDS [get_ports {LMK_1_CLK_SYNTH_DCLKout1_clk_p
[0]}]
set_property DIFF_TERM TRUE [get_ports {LMK_1_CLK_SYNTH_DCLKout1_clk_p[0]}]
###LMK_2_CLKIN_5338_P #diff 1.8Vto Si5338 IN1/IN2
###LMK_3_CLK_SYNTH_SDCLKout3 #diff 1.8Vto N.C.
###LMK_4_CLK_SYNTH_SDCLKout4 #diff MGT 1.8V T6/T5
###LMK_5_CLK_SYNTH_SDCLKout5 #diff 1.8Vto N.C.
###LMK_6_CLK_SYNTH_SDCLKout6 #diff 1.8Vto N.C.
###LMK 7 CLK SYNTH SDCLKout7 #diff MGT 1.8V F6/F5
###LMK_8_CLK_SYNTH_SDCLKout8 #diff 1.8Vto N.C.
###LMK_9_CLK_SYNTH_SDCLKout9 #diff 1.8Vto N.C.
###LMK 10 CLK SYNTH SDCLKout10 #diff 1.8Vto N.C.
###LMK_11_CLK_SYNTH_SDCLKout11 #diff 1.8Vto N.C.
###LMK_12_CLK_SYNTH_SDCLKout12 #diff 1.8Vto N.C.
###LMK_13_CLK_SYNTH_SDCLKout13 #diff 1.8Vto N.C.
#-----
```

Software Design - Vitis

Application

Template location: ./sw_lib/sw_apps/

hello_tec0330

• Hello World as endless loop with output of four frequencies.

scu

• Si5338 I2C Configuration via MicroBlaze MCS.

spi_bootloader

TE modified SPI Bootloader from Henrik Brix Andersen.

Bootloader to load app or second bootloader from flash into DDR.

Here it loads the u-boot.elf from QSPI-Flash to RAM. Hence u-boot.srec becomes redundant.

Descriptions:

- · Modified Files: bootloader.c
- Changes:
 - Change the SPI defines in the header
 - Add some reiteration in the frist spi read call

Additional Software

SI5338

File location "roject folder>\misc\Si5338\Si5338-*.slabtimeproj"

General documentation how you work with this project will be available on Si5338

Appx. A: Change History and Legal Notices

Document Change History

To get content of older revision got to "Change History" of this page and select older document revision number.

Date	Document Revision	Authors	Description
			• 2021.2 release

Error	Error	Error
renderi	renderi	renderi
ng	ng	ng
macro	macro	macro
'page-	'page-	'page-
info'	info'	info'
Ambiguo	Ambiguo	Ambiguo
Ambiguo		Ambiguo
US	us method	US
method		method
overload	overload . ,	overload . ,
ing for	ing for	ing for
method	method	method
jdk.	jdk.	jdk.
proxy27	proxy27	proxy27
9.\$Proxy	9.\$Proxy	9.\$Proxy
4022#ha	4022#ha	4022#ha
sConten	sConten	sConten
tLevelPe	tLevelPe	tLevelPe
rmission	rmission	rmission
Cannot	Cannot	Cannot
resolve	resolve	resolve
which	which	which
method	method	method
to	to	to
invoke	invoke	invoke
for [null,	for [null,	for [null,
class	class	class
java.	java.	java.
lang.	lang.	lang.
String,	String,	String,
class	class	class
com.	com.	com.
atlassian	atlassian	atlassian
confluen	confluen	confluen
ce.	ce.	ce.
pages.	pages.	pages.
Page]	Page]	Page]
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ı]] 11	
due to	due to	due to
overlapp	overlapp	overlapp
ing	ing	ing
prototyp	prototyp	prototyp
es	es	es
between	between	between
:	:	:
[interfac	[interfac	[interfac
e com.	e com.	e com.
atlassian	atlassian	atlassian
confluen	confluen	confluen
ce.user.	ce.user.	ce.user.
Conflue	Conflue	Conflue
nceUser	nceUser	nceUser
, class	, class	, class
java.	java.	java.
lang.	lang.	lang.
String,	String,	String,
class	class	class
com.	com.	com.
atlassian	atlassian	atlassian
confluen	confluen	confluen
ce.core.	ce.core.	ce.core.
Content	Content	Content
EntityOb	EntityOb	EntityOb
ject]	ject]	ject]
[interfac	[interfac	[interfac
e com.	e com.	e com.
atlassian	atlassian	atlassian
.user.	.user.	.user.
User,	User,	User,
class	class	class
java.	java.	java.
lang.	lang.	lang.
String,	String,	String,
class	class	class
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oon.	Com.	com.
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jdk. proxy27 9.\$Proxy 4022#ha sConten tLevelPe rmission . Cannot resolve which method to			ing for	
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9.\$Proxy 4022#ha sConten tLevelPe rmission . Cannot resolve which method to				
4022#ha sConten tLevelPe rmission . Cannot resolve which method to				
sConten tLevelPe rmission . Cannot resolve which method to				
tLevelPe rmission . Cannot resolve which method to				
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which method				
method to				
to				
invoke				
in the state of th			invoke	

for [null, class java. lang. String, class com. atlassian confluen ce. pages. Page] due to overlapp ing prototyp es between [interfac e com. atlassian confluen ce.user. Conflue nceUser , class java. lang. String, class com. atlassian confluen

ce.core.
Content



Document change history.

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Trenz Electronic is registered under WEEE-Reg.-Nr. DE97922676.

Error rendering macro 'page-info'

com.atlassian.confluence.core.ContentEntityObject]

Ambiguous method overloading for method jdk.

proxy279.\$Proxy4022#hasContentLevelPermission. Cannot resolve which method to invoke for [null, class java.lang.String, class com.atlassian.confluence.pages.Page] due to overlapping prototypes between: [interface com.atlassian.confluence.user.

ConfluenceUser, class java.lang.String, class com.atlassian.confluence.core.

ContentEntityObject] [interface com.atlassian.user.User, class java.lang.String, class